

Global UV Curable Wafer Dicing Tape Supply, Demand and Key Producers, 2026-2032

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Abstracts

The global UV Curable Wafer Dicing Tape market size is expected to reach \$ 370 million by 2032, rising at a market growth of 7.3% CAGR during the forecast period (2026-2032).

UV Curable Wafer Dicing Tape is a functional pressure-sensitive tape used in the dicing process of semiconductor wafers, packages, glass, ceramics, sapphire and compound semiconductor materials. It is typically composed of a polyolefin or polyvinyl chloride backing film, a UV-responsive acrylic pressure-sensitive adhesive layer, a release liner and cleanroom-compatible packaging. During wafer dicing or package singulation, the tape provides strong initial adhesion to hold the wafer or workpiece on a metal ring frame, preventing die fly-off, edge chipping and displacement. After dicing, ultraviolet irradiation triggers curing or crosslinking in the adhesive layer and significantly reduces adhesion, enabling easy die pick-up, transfer and subsequent die bonding. Major production regions include Japan, South Korea, China, Taiwan, the United States, and selected European and Southeast Asian markets. Core applications include integrated circuits, power semiconductors, memory devices, sensors, LEDs, advanced packaging and precision electronic material dicing, making the product a key consumable for temporary fixation, clean release and yield control in semiconductor back-end manufacturing.

In 2025, global UV Curable Wafer Dicing Tape production reached approximately 36.00 million to 41.00 million square meters, with mainstream FOB prices ranging from about USD 4.80 to USD 6.40 per square meter. High-cleanliness, anti-static, heat-resistant, solvent-resistant and advanced-packaging grades were generally priced above standard silicon wafer dicing products. From 2026 to 2032, global demand is expected to continue expanding with growth in 300 mm wafers, advanced packaging, power

semiconductors, compound semiconductors and high-precision sensor dicing. Average industry prices are expected to decline moderately as Chinese and Taiwanese supply chains scale up, while high-end product prices are likely to remain resilient.

As the semiconductor industry moves toward higher computing performance, higher integration density and more complex packaging architectures, UV Curable Wafer Dicing Tape is shifting from a process-support consumable to a critical yield-control material in back-end manufacturing. Capacity expansion in AI servers, HBM, advanced logic devices, automotive-grade power semiconductors, compound semiconductors and optoelectronic devices is increasing demand for thin-wafer handling, precision dicing, small-die pick-up and low-residue transfer. Compared with conventional non-UV dicing tapes, UV curable products maintain holding force during dicing and achieve rapid adhesion reduction after UV exposure, making them more suitable for thin wafers, brittle substrates, multi-die packages and high-cleanliness production lines. With rising adoption of 300 mm wafers, advanced packaging, power devices and sensor applications, leading suppliers are improving low-outgassing performance, low ionic contamination, anti-static properties, heat resistance, solvent resistance and compatibility with automated wafer mounting systems. Competition is therefore moving from basic adhesion control to cleanliness, batch stability, customer qualification and process-equipment integration.

The main market challenges are long customer qualification cycles, stringent requirements from leading semiconductor customers for residue, particles, ionic contamination and UV-release stability, and the continued dominance of Japanese and selected international suppliers in high-end applications. For new entrants, coating and slitting capability alone does not constitute semiconductor-grade supply capability; clean manufacturing, adhesive formulation, backing film stability, UV response, aging control and long-term customer validation are all critical barriers. On the demand side, silicon wafer dicing remains the largest base market, while incremental growth is increasingly driven by advanced packaging, power semiconductors, silicon carbide and gallium nitride devices, micro-sensors, LEDs and high-end module dicing. Over the next several years, as semiconductor manufacturing expands across China, Taiwan, South Korea, Japan, Southeast Asia and the United States, UV Curable Wafer Dicing Tape is expected to grow faster than general process tapes, with the market continuing to move toward high-cleanliness, high-reliability and process-specific customization.

This report studies the global UV Curable Wafer Dicing Tape production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for UV Curable Wafer Dicing Tape and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2025 as the base year. This report explores demand trends and competition, as well as details the characteristics of UV Curable Wafer Dicing Tape that contribute to its increasing demand across many markets.

Highlights and key features of the study

Global UV Curable Wafer Dicing Tape total production and demand, 2021-2032, (K Sqm)

Global UV Curable Wafer Dicing Tape total production value, 2021-2032, (USD Million)

Global UV Curable Wafer Dicing Tape production by region & country, production, value, CAGR, 2021-2032, (USD Million) & (K Sqm), (based on production site)

Global UV Curable Wafer Dicing Tape consumption by region & country, CAGR, 2021-2032 & (K Sqm)

U.S. VS China: UV Curable Wafer Dicing Tape domestic production, consumption, key domestic manufacturers and share

Global UV Curable Wafer Dicing Tape production by manufacturer, production, price, value and market share 2021-2026, (USD Million) & (K Sqm)

Global UV Curable Wafer Dicing Tape production by Type, production, value, CAGR, 2021-2032, (USD Million) & (K Sqm)

Global UV Curable Wafer Dicing Tape production by Application, production, value, CAGR, 2021-2032, (USD Million) & (K Sqm)

This report profiles key players in the global UV Curable Wafer Dicing Tape market based on the following parameters - company overview, production, value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include LINTEC Corporation, Nitto Denko Corporation, Furukawa Electric Co., Ltd., Mitsui Chemicals ICT Materia, Inc., Denka Company Limited, Sumitomo Bakelite Co., Ltd., Maxell, Ltd., KGK Chemical Corporation, D&X Co., Ltd., AI Technology, Inc., etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World UV Curable Wafer Dicing Tape market

Detailed Segmentation:

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (K Sqm) and average price (US\$/Sq m) by manufacturer, by Type, and by Application. Data is given for the years 2021-2032 by year with 2025 as the base year, 2026 as the estimate year, and 2027-2032 as the forecast year.

Global UV Curable Wafer Dicing Tape Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

Global UV Curable Wafer Dicing Tape Market, Segmentation by Type:

Roll Tape

Pre Cut Wafer Tape

Frame Mounted Tape

Global UV Curable Wafer Dicing Tape Market, Segmentation by Tape Thickness:

Below 90 Micrometer

90 to 130 Micrometer

Above 130 Micrometer

Global UV Curable Wafer Dicing Tape Market, Segmentation by Wafer Diameter:

300 mm

200 mm

150 mm and Below

Others

Global UV Curable Wafer Dicing Tape Market, Segmentation by Backing Film Material:

Polyolefin

Polyvinyl Chloride

Others

Global UV Curable Wafer Dicing Tape Market, Segmentation by Application:

Silicon Wafer Dicing

Package Dicing

Others

Companies Profiled:

LINTEC Corporation

Nitto Denko Corporation

Furukawa Electric Co., Ltd.

Mitsui Chemicals ICT Materia, Inc.

Denka Company Limited

Sumitomo Bakelite Co., Ltd.

Maxell, Ltd.

KGK Chemical Corporation

D&X Co., Ltd.

AI Technology, Inc.

Ultron Systems, Inc.

Semiconductor Equipment Corporation

Microworld SAS

DAEHYUN ST Co., Ltd.

MTI Co., Ltd.

ANYONE Co., Ltd.

Mingkun Technologies Co., Ltd.

Solar Plus Company

Koatech Technology Corporation

NDS Co., Ltd.

Cybrid Technologies Inc.

Shenzhen Xinst Technology Co., Ltd.

Xiamen DCA Tape New Material Co., Ltd.

Han Kook Tapes Sdn Bhd

Sri Vasavi Adhesive Tapes Limited

Key Questions Answered:

1. How big is the global UV Curable Wafer Dicing Tape market?
2. What is the demand of the global UV Curable Wafer Dicing Tape market?
3. What is the year over year growth of the global UV Curable Wafer Dicing Tape market?
4. What is the production and production value of the global UV Curable Wafer Dicing Tape market?
5. Who are the key producers in the global UV Curable Wafer Dicing Tape market?
6. What are the growth factors driving the market demand?

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